

S/N 09/652,619

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Gurtej Singh Sandhu et al.

Examiner: Renee Berry

Serial No.: 09/652,619

Group Art Unit: 2818

Filed: August 31, 2000

Docket: 303.085US4

Title: METHOD FOR FORMING A METALLIZATION LAYER

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents
Washington, D.C. 20231

In response to the Restriction Requirement mailed September 25, 2001, Applicant elects, without traverse, Group I (claims 21-31 and 91-99). Applicant respectfully cancels remaining claims 55-90 (Groups II-IV) without prejudice, and reserves the right to reintroduce them in a divisional application at a later date.

The Examiner is invited to contact Applicant's Representatives at the below-listed telephone number if there are any questions regarding this Response or if prosecution of this application may be assisted thereby.

Respectfully submitted,

GURTEJ SINGH SANDHU ET AL.

By their Representatives,

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
P.O. Box 2938
Minneapolis, MN 55402
(612) 373-6960

Date 10-25-01

By Marvin L. Beekman
Marvin L. Beekman
Reg. No. 38,377

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner of Patents, Washington, D.C. 20231, on this 25 day of October, 2001.

Name

Tina Pyg

Signature

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